# STK433-840N-E

# Thick-Film Hybrid IC 4ch class-AB Audio Power IC 40W×4ch

#### Overview

The STK433-840N-E is 4 channels class-AB audio frequency power amplifier hybrid IC.

#### Application

• Audio Power amplifiers

#### Features

- Pin-to-pin compatible outputs ranging from 40W to 80W.
- Output load impedance:  $R_L = 6\Omega$  recommended.
- Allows the use of predesigned applications for standby and mute circuit.

#### Series model

	STK433-040N-E	STK433-060N-E	STK433-130N-E							
Output1 (10%/1kHz)	$40W\times2ch$	$50W\times 2ch$	$150W \times 2ch$							
Output2 (0.4%/20Hz to 20kHz)	$25W\times2ch$	$35W\times 2ch$	$100W\times2ch$							
Max. rating V <sub>CC</sub> (quiescent)	±38V	±46V	±71.5V							
Max. rating V <sub>CC</sub> (6 $\Omega$ )	±36V	±40V	±63V							
Recommended operating V <sub>CC</sub> (6 $\Omega$ )	±24V	±27V	±44V							
Dimensions (excluding pin height)	47.0mm×25.	67.0mm×25.6mm×9.0mm								

	STK433-330N-E	STK433-840N-E	STK433-890N-E
Output1 (10%/1kHz)	$150W\times3ch$	$40W\times4ch$	$80W \times 4ch$
Output2 (0.4%/20Hz to 20kHz)	$100W\times 3\text{ch}$	$25W \times 4ch$	50W  imes 4ch
Max. rating V <sub>CC</sub> (quiescent)	±71.5V	±38V	±54V
Max. rating $V_{CC}$ (6 $\Omega$ )	±63V	±36V	±47V
Recommended operating V <sub>CC</sub> (6 $\Omega$ )	<u>+</u> 44V	±25V	±34V
Dimensions (excluding pin height)	64.0mm×36.6mm×9.0mm	64.0mm×31.1mm×9.0mm	78.0mm×44.1mm×9.0mm

#### Specifications

**Absolute Maximum Ratings** at  $Ta = 25^{\circ}C$ ,  $Tc = 25^{\circ}C$  unless otherwise specified

Parameter	Symbol	Conditions	Ratings	Unit
Maximum power supply voltage	V <sub>CC</sub> max (0)	Non signal	±38	V
	V <sub>CC</sub> max (1)	Signal, $R_L \ge 6\Omega$	±36	V
	V <sub>CC</sub> max (2)	Signal, R <sub>L</sub> = 4 $\Omega$	±30	V
Minimum operation supply voltage	V <sub>CC</sub> min		±10	V
#13 Operating voltage *5	VST OFF max	#13pin voltage	-0.3 to +5.5	V
Thermal resistance	өј-с	Per power transistor	4.2	°C/W
Junction temperature	Tj max	Both the Tj max and Tc max	150	°C
Operating substrate temperature	Tc max	conditions must be met.	125	°C
Storage temperature	Tstg		-30 to +125	°C
Allowable time for load short-circuit *4	ts	$V_{CC}$ = ±25V, R <sub>L</sub> = 6 $\Omega$ , f = 50Hz P <sub>O</sub> = 25W, 1ch drive	0.3	s

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 12 of this data sheet.



- Miniature package.
- Allowable load shorted time: 0.3 second

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				С								
Parameter		Symbol	V <sub>CC</sub> [V]	f [Hz]	P <sub>O</sub> [W]	THD [%]		min	typ	max	Unit	
Output power	*1	P <sub>O</sub> 1	±25	20 to 20k		0.6		23	25			
		P <sub>O</sub> 2	±25	1k		10			40		W	
Total harmonic distortion	*1	THD 1	±25	20 to 20k						0.6		
		THD 2	±25	1k	5.0		VG=30dB		0.02		%	
Frequency characteristics	*1	fL, fH	±25		1.0		+0 -3dB		20 to 50k		Hz	
Input impedance		ri	±25	1k	1.0				55		kΩ	
Output noise voltage	*3	V <sub>NO</sub>	±30				Rg=2.2kΩ			1.0	mVrms	
Quiescent current		ICCO	±30				No load	30	60	140	mA	
Quiescent current at stand-by	/	ICST	±30				VST=0V			1.0	mA	
Neutral voltage		V <sub>N</sub>	±30					-70	0	+70	mV	
#13 Stand-by ON threshold	*5	VST ON	±25				Stand-by		0	0.6	V	
#13 Stand-by OFF threshold	*5	VST OFF	±25				Operation	2.5	3.0	5.5	V	

Note

\*1. 1channel operation.

\*2. All tests are measured using a constant-voltage supply unless otherwise specified

\*3. The output noise voltage is peak value of an average-reading meter with a rms value scale (VTVM). A regulated AC supply (50Hz) should be used to eliminate the effects of AC primary line flicker noise

\*4. Allowable time for load short-circuit and output noise voltage are measured using the specified transformer power supply.

\*5. The impression voltage of '#13 (Stand-By) pin' must not exceed the maximum rating. Power amplifier operate by impressing voltage +2.5 to +5.5V to '#13 (Stand-By) pin'.

\* Please connect - PreV<sub>CC</sub> pin (#1 pin) with the stable minimum voltage.

and connect so that current does not flow in by reverse bias.

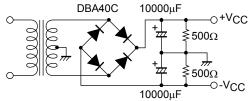
\* In case of heat sink design, we request customer to design in the condition to have assumed market.

\* The case of this Hybrid-IC is using thermosetting silicon adhesive (TSE322SX).

\* Weight of HIC : (typ) 20.6g

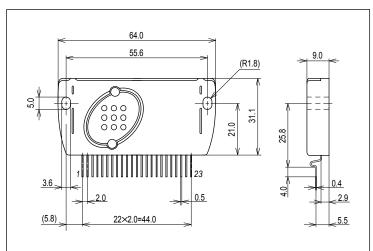
Outer carton dimensions (W×L×H) : 502mm×247mm×282mm

Specified transformer power supply (Equivalent to MG-200)



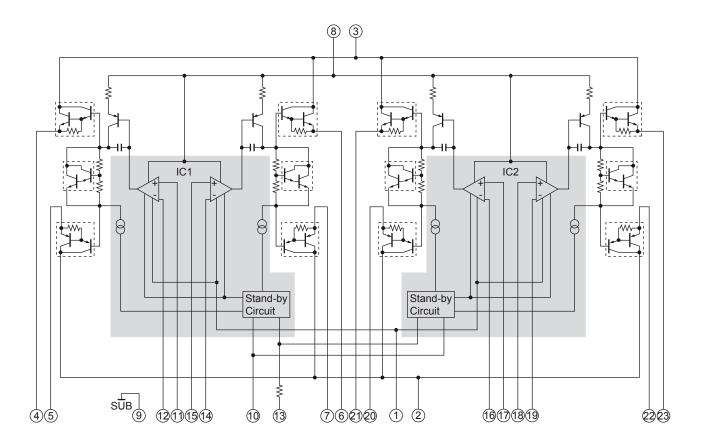
### Package Dimensions

unit : mm (typ)

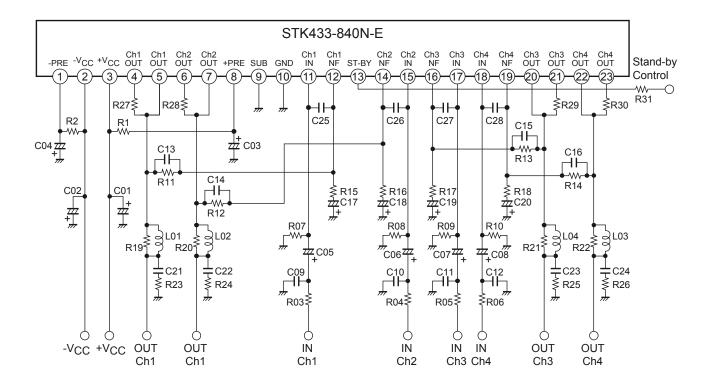


RoHS directive pass

#### **Equivalent Circuit**

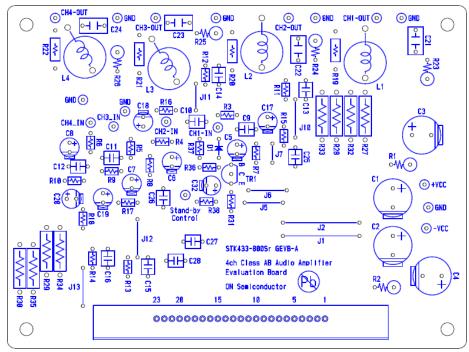


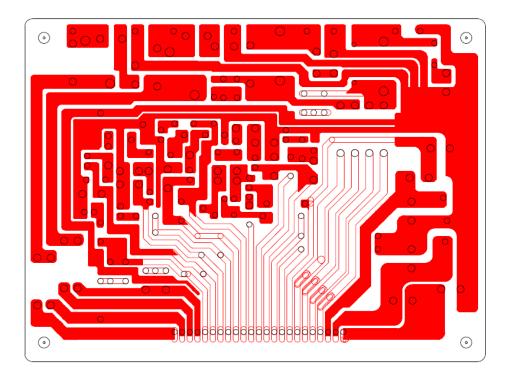
#### **Application Circuit**



#### PCB Layout Example

Top view





#### STK433-800NSr PCB PARTS LIST

#### PCB Name : STK433-800Sr GEVB - A

Location No.		RATING	Component				
Lood			STK433-840N-E/890N-E				
Hybrid IC#1 Pin Posi	tion	-	1				
R01, R02		100Ω, 1W	0				
R03, R04, R05, R06		1kΩ, 1/6W	0				
R07, R08, R09, R10,	, R11, R12, R13, R14	56KΩ, 1/6W	0				
R15, R16, R17, R18		1.8KΩ, 1/6W	0				
R19, R20, R21, R22		4.7Ω, 1/4W	0				
R23, R24, R25, R26		4.7Ω, 1W	0				
R27, R28, R29, R30		0.22Ω, 5W	0				
R32, R33, R34, R35		Jumper	Short				
C01, C02, C03, C04		100μF, 100V	0				
C05, C06, C07, C08		2.2μF, 50V	0				
C09, C10, C11, C12		470pF, 50V	0				
C13, C14, C15, C16		5pF, 50V	0				
C17, C18, C19, C20		10μF, 16V	0				
C21, C22, C23, C24		0.1µF, 50V	0				
C25, C26, C27, C28		100pF, 50V	0				
L01, L02, L03, L04		ЗµН	0				
	Tr1	VCE $\geq$ 50V, IC $\geq$ 10mA	0				
	D1	Di	0				
Stand-By	R31	1.3kΩ, 1/6W	0				
Control	R36	33kΩ, 1/6W	0				
Circuit	R37	1kΩ, 1/6W	0				
	R38	2kΩ, 1/6W	0				
	C32	33μF, 10V	0				
J1,J2,J5,J6,J7,J10,J	11,J12,J13	Jumper	0				
		-					
		-					
		-					

#### **Recommended external components**

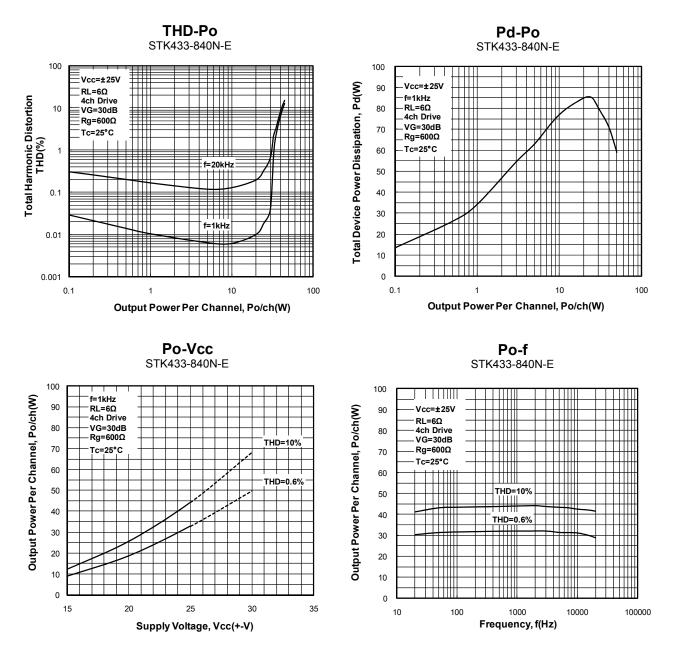
#### STK433-840N-E/890N-E

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Pin Layout [STK433-000N/-100N/-800Nsr Pin Layout]

[51K455-000N/-100N/-800]	181	1 III	Ldy	out				1				1				1							
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15								
(Size) 47.0mm×25.6mm×9.0mm						2c	h clas	sAB/	2.00r	nm													
STK433-040N 40W/JEITA	-	-	+	0	0	0	0	+			Ι	Ν	S	Ν	Ι								
STK433-060N 50W/JEITA	Ρ	V	V	U	U	U	U	Р	S	G	Ν	F	Т	F	Ν								
	R	С	С	Т	Т	Т	Т	R	U	Ν	/	/	A	1	/								
	Е	С	С	/	/	/	/	E	В	D	С	C	N	С	С								
(Size) 67.0mm×25.6mm×9.0mm				С Н	С Н	С Н	С Н				Н 1	H 1	D 	Н 2	Н 2								
STK433-130N 150W/JEITA				1	1	2	2						В										
				+	-	+	-						Y										
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23
(Size) 64.0mm×31.1mm×9.0mm										4cl	h clas	sAB/	2.00r	nm									
STK433-840N 40W/JEITA	-	-	+	0	0	0	0	+			I	Ν	S	Ν	1	Ν	Ι	Ι	Ν	0	0	0	0
	Ρ	V	V	U	U	U	U	Р	s	G	Ν	F	т	F	Ν	F	Ν	Ν	F	U	U	U	U
	R	С	С	Т	Т	Т	Т	R	U	Ν	1	1	А	1	/	1	1	1	/	Т	Т	Т	Т
	Е	С	С	/	/	1	1	Е	В	D	С	С	Ν	С	С	С	С	С	С	1	1	/	/
(Size) 78.0mm×44.1mm×9.0mm				С	С	С	С				Н	Н	D	Н	Н	Н	Н	Н	Н	С	С	С	С
				H	H	Н	Н				1	1		2	2	3	3	4	4	Н	Н	H	H
STK433-890N 80W/JEITA				1+	1	2+	2						B Y							3	3 +	4	4+
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#### **Characteristic of Evaluation Board**



#### A Thermal Design Tip For STK433-840N-E Amplifier

[Thermal Design Conditions] The thermal resistance (θc-a) of the heat-sink which manages the heat dissipation inside the Hybrid IC will be determined as follow: (Condition 1) The case temperature (Tc) of the Hybrid IC should not exceed 125°C Pd × θc-a + Ta < 125°C
<ul> <li>(Condition 1) The case temperature (Tc) of the Hybrid IC should not exceed 125°C Pd × θc-a + Ta &lt; 125°C</li> <li>Where Ta : the ambient temperature for the system</li> <li>(Condition 2) The junction temperature of each power transistor should not exceed 150°C Pd × θc-a + Pd/N × θj-c + Ta &lt; 150°C</li> <li>Where N : the number of transistors (two for 1 channel , ten for channel)</li> </ul>
$Pd \times \theta c-a + Ta < 125^{\circ}C \cdots (1)$ $Where Ta : the ambient temperature for the system$ (Condition 2) The junction temperature of each power transistor should not exceed 150°C $Pd \times \theta c-a + Pd/N \times \theta j-c + Ta < 150^{\circ}C \cdots (2)$ $Where N : the number of transistors (two for 1 channel, ten for channel)$
Where Ta : the ambient temperature for the system(Condition 2) The junction temperature of each power transistor should not exceed 150°C $Pd \times \theta c$ -a + $Pd/N \times \theta j$ -c + Ta < 150°C
(Condition 2) The junction temperature of each power transistor should not exceed 150°C $Pd \times \theta c - a + Pd/N \times \theta j - c + Ta < 150$ °C (2) Where N : the number of transistors (two for 1 channel , ten for channel)
$Pd \times \theta c-a + Pd/N \times \theta j-c + Ta < 150^{\circ}C$ (2) Where N : the number of transistors (two for 1 channel , ten for channel)
Where N : the number of transistors (two for 1 channel , ten for channel)
$\theta$ j-c : the thermal resistance of each transistor (see specification)
Note that the power consumption of each power transistor is assumed to be equal to the total power dissipation (Pd) divided by the number of transistors (N).
From the formula (1) and (2), we will obtain:
$\theta c - a < (125 - Ta)/Pd$ (1)
$\theta c-a < (150 - Ta)/Pd - \theta j-c/N$ (2)
The value which satisfies above formula (1)' and (2)' will be the thermal resistance for a desired heat-sink.
Note that all of the component except power transistors employed in the Hybrid IC comply with above conditions.
[Example of Thermal Design]
Generally, the power consumption of actual music signals are being estimated by the continuous signal of
$1/8 P_{O}$ max. (Note that the value of $1/8 P_{O}$ max may be varied from the country to country.)
(Sample of STK433-840N-E ; 25W×4ch)
If V <sub>CC</sub> is $\pm 25V$ , and R <sub>L</sub> is 6 $\Omega$ , then the total power dissipation (Pd) of inside Hybrid IC is as follow;
Pd = 55.0W (at 3.125W output power,1/8 of P <sub>O</sub> max)
There are eight (8) transistors in Audio Section of this Hybrid IC, and thermal resistance ( $\theta$ j-c) of each transistor is
4.2°C/W. If the ambient temperature (Ta) is guaranteed for 50°C, then the thermal resistance ( $\theta$ c-a) of a desired heat-
sink should be;
From (1)' $\theta c - a < (125 - 50)/55.0$
<1.36
From (2)' $\theta c - a < (150 - 50)/55.0 - 4.2/8$

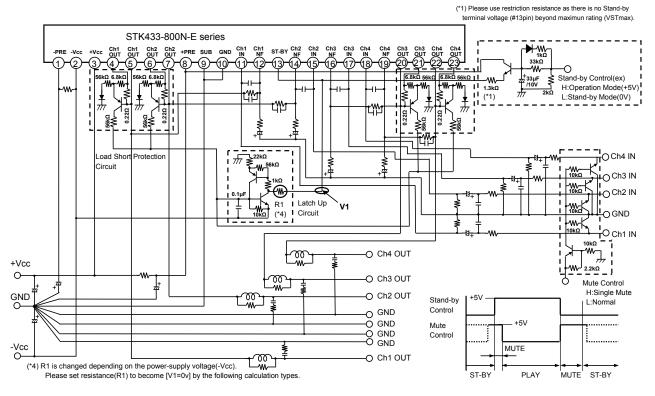
< 1.29

Therefore, in order to satisfy both (1)' and (2)', the thermal resistance of a desired Heat-sink will be 1.29°C/W.

#### [Note]

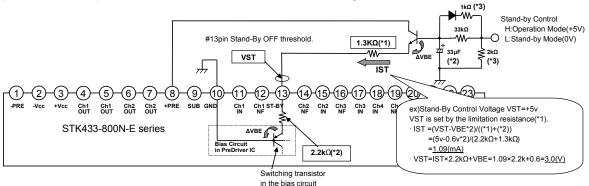
Above are reference only. The samples are operated with a constant power supply. Please verify the conditions when your system is actually implemented.

#### STK433-800 series Stand-by Control & Mute Control & Load-Short Protection Application



## [STK433-800N-E series Stand-By Control Example]

- [Feature]
- The pop noise which occurs to the time of power supply on/off can be improved substantially by recommendation Stand-By Control Application.
- Stand-By Control can be done by additionally adjusting the limitation resistance to the voltage such as micom, the set design is easy.
- (Reference circuit) STK433-800N-E series test circuit To Stand-By Control added +5V.



[Operation explanation] #13pin Stand-By Control Voltage VST

(1) Operation Mode

The switching transistor in the bias circuit turns on and places the amplifier into the operating mode, when 13pin (VST) voltage added above 2.5V (typ 3.0V).

(2) Stand-By Mode

When 13pin (VST) voltage is stopped (= 0V), the switching transistor in the bias circuit turn off, placing the amplifier into the standby mode.

- (\*1) The current limiting resistor must be used to ensure that stand-by pin (13pin) voltage does not exceed its maximum rated value VST max.
- (\*2) The pop noise level when the power is turned on can be reduced by setting the time constant with a capacitor in operating mode.
- (\*3) Determines the time constant at which the capacitor (\*2) is discharged in stand-by mode.

#### ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
STK433-840N-E	SIP23 (Pb-Free)	20 / Bulk Box

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